

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: ERIC J. BERGMAN  
APPLICATION No.: 10/631,376  
FILED: JULY 30, 2003  
FOR: **METHODS OF THINNING A SILICON WAFER  
USING HF AND OZONE**

EXAMINER: Z. EL-ARINI  
ART UNIT: 1746  
CONF. NO: 2135

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed 10/3/2006, please amend the  
Application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the claims are reflected in the listing of claims which begins  
on page 3 of this paper.

Remarks begin on page 7 of this paper.


[Continued on Next Page.]

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Certificate of Electronic Filing

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being electronically  
filed with the U.S. Patent and Trademark Office on the date entered below

December 5, 2006  
Date of Electronic Submission

  
Debbie Gilbert